

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
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CORRESPONDENCE DATA															
<p>Fax Number: (202)659-9344</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 202-659-9076</p> <p>Email: gdavis@roylance.com</p> <p>Correspondent Name: ROYLANCE, ABRAMS, BERDO & GOODMAN, L.L.P</p> <p>Address Line 1: 1300 19TH STREET, N.W.</p> <p>Address Line 2: SUITE 600</p> <p>Address Line 4: WASHINGTON,, DISTRICT OF COLUMBIA 20036</p>															
ATTORNEY DOCKET NUMBER:	56941														

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PATENT
REEL: 023993 FRAME: 0389

NAME OF SUBMITTER:

Garrett V. Davis

Total Attachments: 2

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

A S S I G N M E N T

WHEREAS, We, (1) Makoto MATSUMOTO, (2) Toshihiro TAKAAI, (3) Yorimichi DAIROKU, (4) Shinichi FUJINO, (5) Satoshi MATSUMOTO and (6) Seiji KATO, citizens of JAPAN, residing respectively at (1) 1870-A201, Tenma, Otsu-ku, Himeji-shi, Hyogo 671-1143 Japan (2) 1-10-15-503, Jokoji, Amagasaki-shi, Hyogo 660-0811 Japan, (3) 5725-12, Ushimado, Ushimado-cho, Setouchi-shi, Okayama 701-4302 Japan (4) 26-2, 4-chome, Komatsu-cho, Hirohata-ku, Himeji-shi, Hyogo 671-1152 Japan (5) 781-2, Shinden, Ako-shi, Hyogo 678-0255 Japan and (6) 525-13, Tenma, Otsu-ku, Himeji-shi, Hyogo 671-1143 Japan (hereinafter ASSIGNORS), have made a certain invention entitled PROCESS FOR PRODUCING WATER-ABSORBING RESIN for which we are making application for Letters Patent of the United States, which application has been executed concurrently herewith; and

WHEREAS, NIPPON SHOKUBAI CO., LTD., a corporation duly organized under the laws of Japan, located and doing business at 1-1, Koraibashi 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0043 Japan (hereinafter ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to us by said ASSIGNEE the receipt and sufficiency of which is hereby acknowledged, we, the ASSIGNORS and, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States and all countries foreign thereto; and in, to and under the aforesaid United States application and any corresponding foreign applications and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in any country; and our right to file said foreign applications and claim priority under the provisions of the International Convention; and any Letters Patent of the United States or any foreign country issued or granted on said invention and/or said applications;

AND WE HEREBY authorize and request the Patent Office or other issuing authority to issue any and all patents on said invention and/or said application to said ASSIGNEE as sole assignee; and we further hereby authorize said ASSIGNEE to file and prosecute any of said foreign applications in its own name;

AND WE HEREBY covenant that we have the full right to convey the entire right, title and interest herein assigned and that we have not executed and will not execute any assignment or other instrument in conflict herewith;

AND WE HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in all countries, and likewise we make these provisions binding upon our heirs, legal representatives and/or administrators.

IN WITNESS WHEREOF, we have hereunder set our hand and seal.

February 16, 2010
Date

Makoto Matsumoto
Name Makoto MATSUMOTO

February 16, 2010
Date

Toshihiro Takai
Name Toshihiro TAKAAI

February 16, 2010
Date

Yorimichi Dairoku
Name Yorimichi DAIROKU

February 16, 2010
Date

Shinichi Fujino
Name Shinichi FUJINO

February 16, 2010
Date

Satoshi Matsumoto
Name Satoshi MATSUMOTO

February 16, 2010
Date

Seiji KATO
Name Seiji KATO